International Rectifier

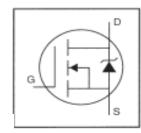
IRL540NS/LPbF

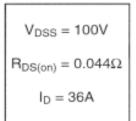
- Advanced Process Technology
- Surface Mount (IRL540NS)
- Low-profile through-hole (IRL540NL)
- 175°C Operating Temperature
- · Fast Switching
- Fully Avalanche Rated
- Lead-Free
 Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The D²Pak is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²Pak is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0W in a typical surface mount application.

The through-hole version (IRF540NL) is available for lowprofile applications.







Absolute Maximum Ratings

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V®	36	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V®	26	A
I _{DM}	Pulsed Drain Current ①⑤	120	
P _D @T _A = 25°C	Power Dissipation	3.8	W
P _D @T _C = 25°C	Power Dissipation	140	W
	Linear Derating Factor	0.91	W/°C
V _{GS}	Gate-to-Source Voltage	± 16	V
E _{AS}	Single Pulse Avalanche Energy@©	310	mJ
I _{AR}	Avalanche Current®	18	A
E _{AR}	Repetitive Avalanche Energy⊕	14	mJ
dv/dt	Peak Diode Recovery dv/dt 35	5.0	V/ns
T _J	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	

Thermal Resistance

	Parameter	Тур.	Max.	Units
Resc	Junction-to-Case	_	1,1	00 MI
R _{BJA}	Junction-to-Ambient (PCB Mounted,steady-state)**		40	°C/W

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	100	_		٧	$V_{GS} = 0V, I_D = 250\mu A$
ΔV _{(BR)DSS} /ΔT _J	Breakdown Voltage Temp. Coefficient		0.11	_	V/°C	Reference to 25°C, I _D = 1mA®
		_	_	0.044	Ω	V _{GS} = 10V, I _D = 18A ④
R _{DS(on)}	Static Drain-to-Source On-Resistance		_	0.053		V _{GS} = 5.0V, I _D = 18A ④
		_	_	0.063		V _{GS} = 4.0V, I _D = 15A ④
V _{GS(th)}	Gate Threshold Voltage	1.0	_	2.0	٧	$V_{DS} = V_{GS}, I_D = 250 \mu A$
9ts	Forward Transconductance	14	_		S	V _{DS} = 25V, I _D = 18A®
	Drain-to-Source Leakage Current	_		25	А	V _{DS} = 100V, V _{GS} = 0V
DSS			_	250	_ ^	V _{DS} = 80V, V _{GS} = 0V, T _J = 150°C
1	Gate-to-Source Forward Leakage	_	_	100	- ^	V _{GS} = 16V
GSS	Gate-to-Source Reverse Leakage	_	_	-100	nΑ	V _{GS} = -16V
Qg	Total Gate Charge	_	_	74		I _D = 18A
Qgs	Gate-to-Source Charge	_		9.4	nC	$V_{DS} = 80V$
Q _{gd}	Gate-to-Drain ("Miller") Charge	_		38	1	V _{GS} = 5.0V, See Fig. 6 and 13 ⊕ ⑤
t _{d(on)}	Turn-On Delay Time		11	_		V _{DD} = 50V
tr	Rise Time		81		ns.	I _D = 18A
t _{d(off)}	Turn-Off Delay Time		39		110	$R_G = 5.0\Omega$, $V_{GS} = 5.0V$
t _f	Fall Time	_	62	_		R _D = 2.7Ω, See Fig. 10 ④ ⑤
L _S	Internal Source Inductance	_	7.5	_	nH	Between lead,
	Internal Source inductance					and center of die contact
Ciss	Input Capacitance	_	1800			$V_{GS} = 0V$
Coss	Output Capacitance	_	350	_	pF	$V_{DS} = 25V$
Crss	Reverse Transfer Capacitance		170	_		f = 1.0MHz, See Fig. 53

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			26		MOSFET symbol
	(Body Diode)	36		A	showing the	
I _{SM}	Pulsed Source Current			100		integral reverse
	(Body Diode) ①⑤			120		p-n junction diode.
V _{SD}	Diode Forward Voltage	_	_	1.3	٧	T _J = 25°C, I _S = 18A, V _{GS} = 0V ⊕ ⑤
t _{rr}	Reverse Recovery Time	_	190	290	ns	T _J = 25°C, I _F = 18A
Qrr	Reverse RecoveryCharge	_	1.1	1.7	μC	di/dt = 100A/μs ⊕ ⑤
ton	Forward Tum-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L _S +L _D)				

Notes:

- Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- Pulse width ≤ 300µs; duty cycle ≤ 2%.
- $\begin{tabular}{ll} \hline \& Starting $T_J=25^\circ$C, $L=1.9mH$\\ $R_G=25\Omega$, $I_{AS}=18A$. (See Figure 12) \\ \hline \end{tabular}$
- © Uses IRL540N data and test conditions
- ③ $I_{SD} \le 18A$, $di/dt \le 180A/\mu s$, $V_{DD} \le V_{(BR)DSS}$, $T_J \le 175^{\circ}C$
- ** When mounted on 1" square PCB (FR-4 or G-10 Material).
 For recommended soldering techniques refer to application note #AN-994.

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IRL540NS/LPbF

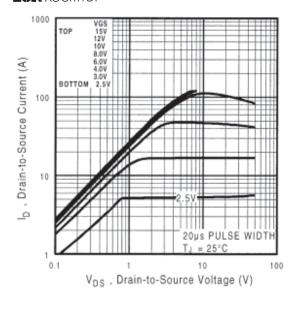
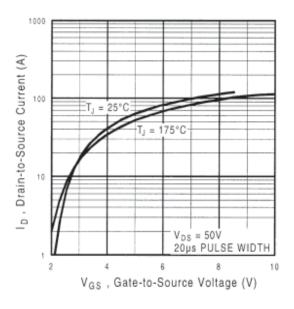


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics



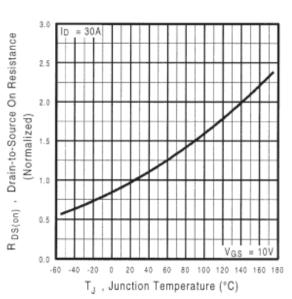


Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature

International **TOR** Rectifier

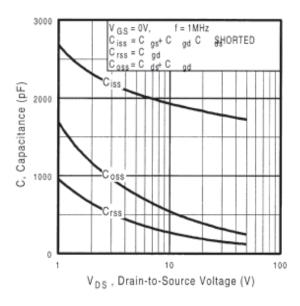


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

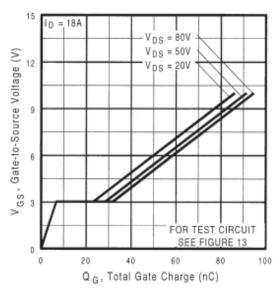


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

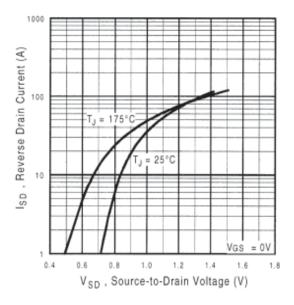


Fig 7. Typical Source-Drain Diode Forward Voltage

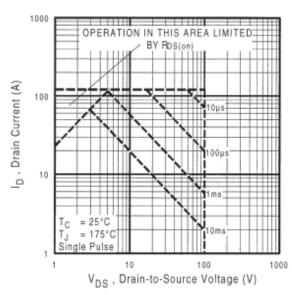


Fig 8. Maximum Safe Operating Area

International TOR Rectifier

40 (V) the state of the state o

Fig 9. Maximum Drain Current Vs. Case Temperature

IRL540NS/LPbF

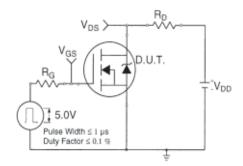


Fig 10a. Switching Time Test Circuit

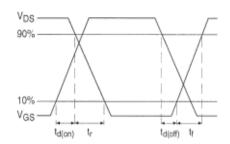


Fig 10b. Switching Time Waveforms

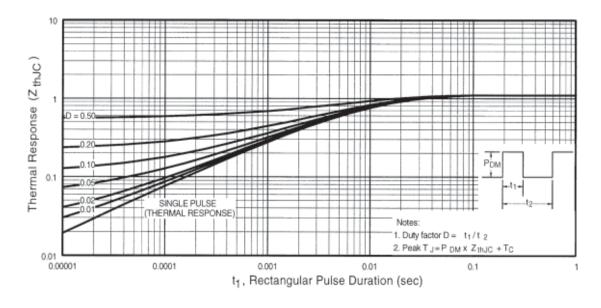


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

International TOR Rectifier

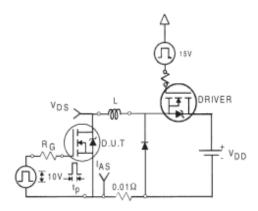


Fig 12a. Unclamped Inductive Test Circuit

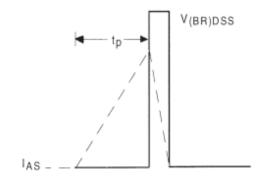


Fig 12b. Unclamped Inductive Waveforms

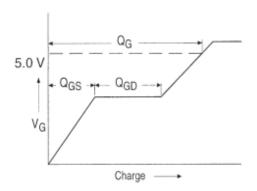


Fig 13a. Basic Gate Charge Waveform

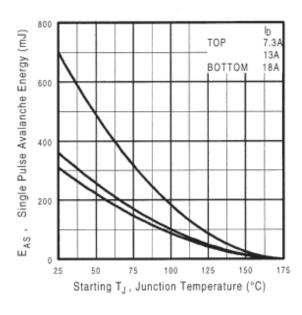


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

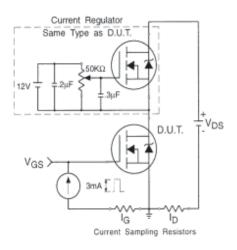
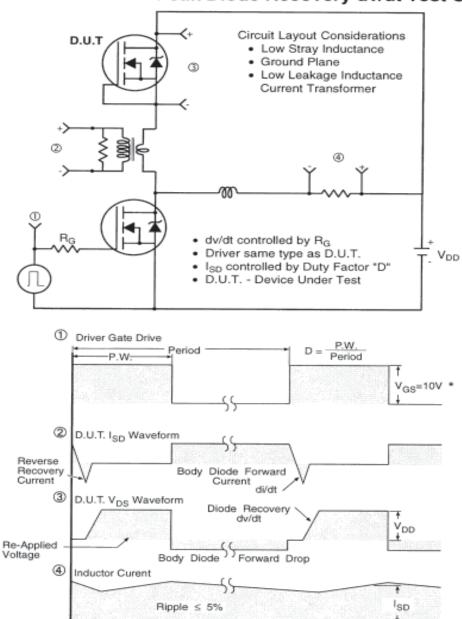


Fig 13b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



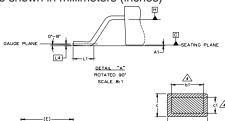
* V_{GS} = 5V for Logic Level Devices

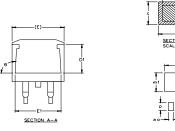
Fig 14. For N-Channel HEXFETS

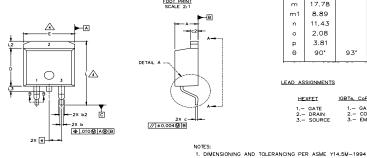
International IOR Rectifier

D²Pak Package Outline









S		N			
M B O	MILLIM	ETERS	INCHES		NOTES
O L	MIN.	MAX.	MIN.	MAX.	E S
Α	4.06	4.83	.160	.190	
A1		0.127		.005	
b	0.51	0.99	.020	.039	
ь1	0.51	0.89	.020	.035	4
ь2	1.14	1.40	.045	.055	
С	0.43	0.63	.017	.025	
c1	0.38	0.74	.015	.029	4
c2	1.14	1.40	.045	.055	
D	8.51	9.65	.335	.380	3
D1	5.33		.210		
E	9.65	10.67	.380	.420	3
E1	6.22		.245		
e	2.54	BSC	.100 BSC		
L	14.61	15.88	.575	.625	
L1	1.78	2.79	.070	.110	
L2		1.65		.065	
L3	1.27	1.78	.050	.070	
L4	0.25 BSC		.010	.010 BSC	
m	17.78		.700		
m1	8.89		.350		
n	11.43		.450		
0	2.08		.082		
р	3.81		.150		
0	90*	93*	90°	93*	
	·	<u>'</u>		٠	

LEAD ASSIGNMENTS

HEXFET	IGBTs, CoPACK	DIODES
1 GATE	1 GATE	1 ANODE *
2 DRAIN	2 COLLECTOR	2 CATHODE
3 SOURCE	3 EMITTER	3 ANODE

* PART DEPENDENT.

PART NUMBER

DATE CODE

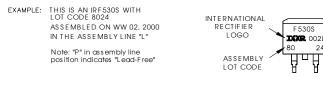
LINE L

YE AR 0 = 2000 WEEK 02

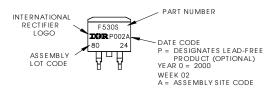


- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
- 5. CONTROLLING DIMENSION: INCH.

D²Pak Part Marking Information (Lead-Free)







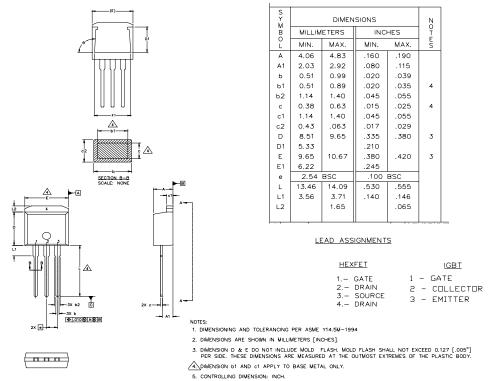
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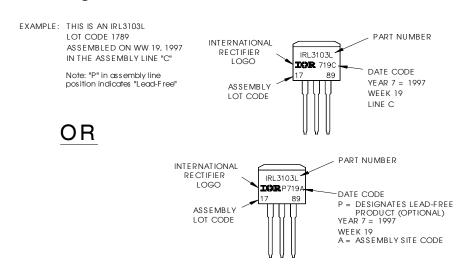
IRL540NS/LPbF

TO-262 Package Outline

Dimensions are shown in millimeters (inches)



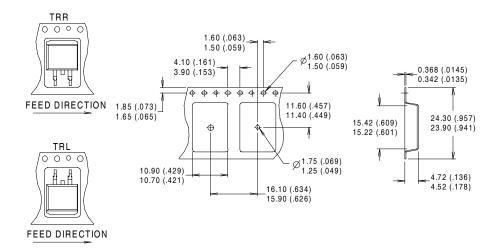
TO-262 Part Marking Information

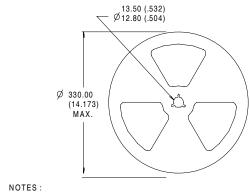


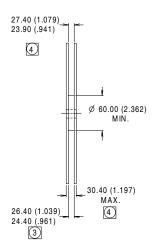
International IOR Rectifier

D²Pak Tape & Reel Information

Dimensions are shown in millimeters (inches)







COMFORMS TO EIA-418.

- 2. CONTROLLING DIMENSION: MILLIMETER.

 33 DIMENSION MEASURED @ HUB.
- INCLUDES FLANGE DISTORTION @ OUTER EDGE.

Data and specifications subject to change without notice.



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